



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6020L uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

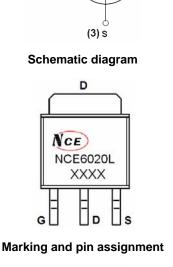
- V_{DS} =60V,I_D =20A
 R_{DS(ON)} <44mΩ @ V_{GS}=10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

Power management

100% UIS TESTED!

100% ΔVds TESTED!



(2) D

(1) GO



TO-251S top view

Package Marking and Ordering Information

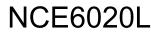
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6020L	NCE6020L	TO-251S	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	20	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	14	A
Pulsed Drain Current	I _{DM}	45	A
Maximum Power Dissipation	PD	30	W
Derating factor		0.2	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	72	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



Pb Free Product



Thermal Characteristic

	Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	5	°C /W
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Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	2.0	3.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =10A	-	37	44	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =4.5A	11	-	-	S
Dynamic Characteristics (Note4)	·		•			
Input Capacitance	C _{lss}		-	500	-	PF
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	60	-	PF
Reverse Transfer Capacitance	C _{rss}		-	25	-	PF
Switching Characteristics (Note 4)	·		•			
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =6.7Ω	-	2.6	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	16.1	-	nS
Turn-Off Fall Time	t _f		-	2.3	-	nS
Total Gate Charge	Qg		-	14		nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =4.5A, V _{GS} =10V	-	2.9		nC
Gate-Drain Charge	Q _{gd}	v _{GS} -10v	-	5.2		nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	35	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	53	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE				y LS+LD)

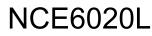
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ C$, V_{DD}=30V , V_G=10V , L=0.1mH , Rg=25\Omega

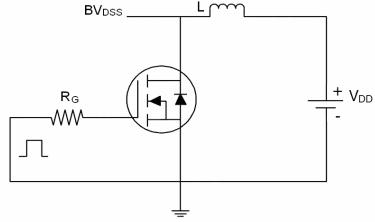


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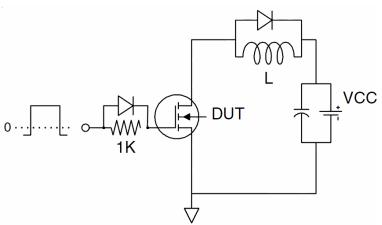
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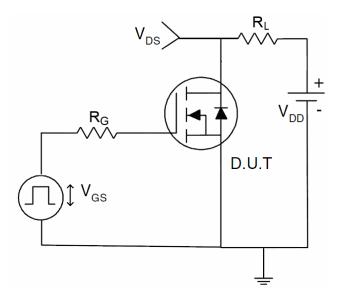
Test Circuit 1) E_{AS} test Circuit



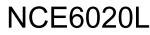
2) Gate charge test Circuit



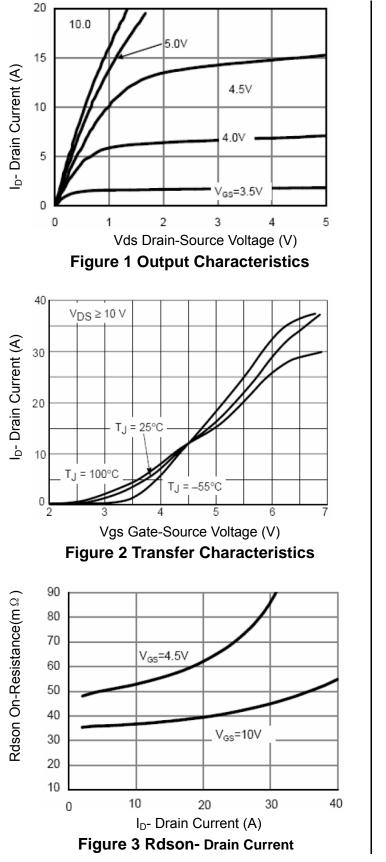
3) Switch Time Test Circuit

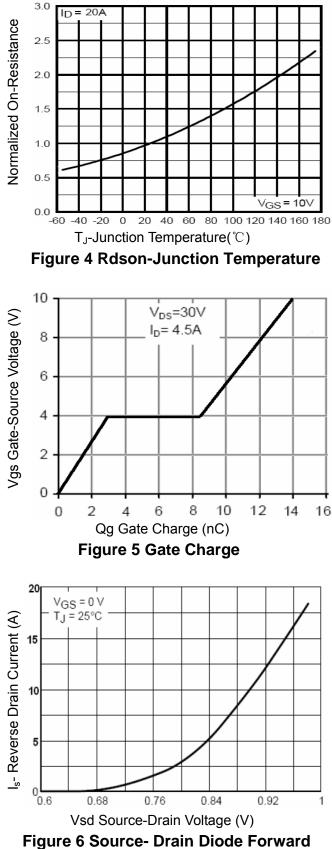






Typical Electrical and Thermal Characteristics (Curves)

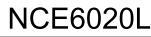


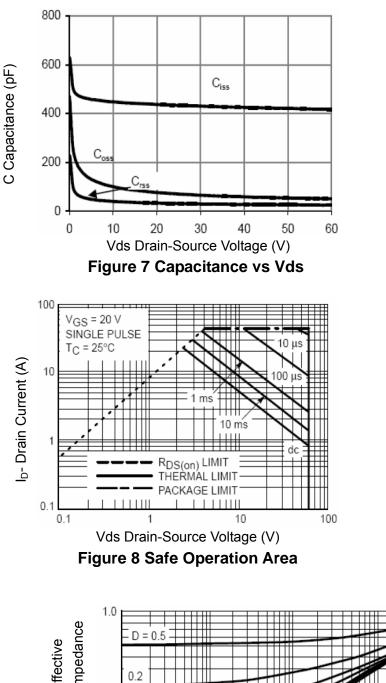




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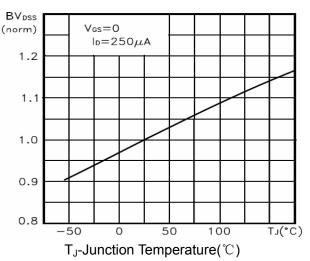


Figure 9 BV_{DSS} vs Junction Temperature

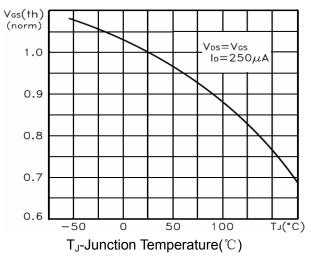
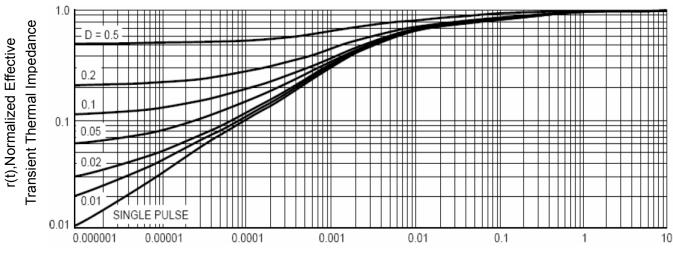
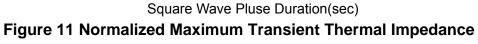


Figure 10 V_{GS(th)} vs Junction Temperature

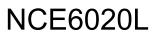




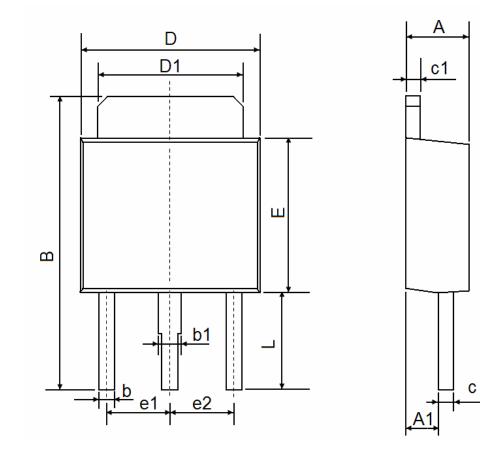


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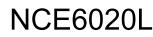
TO-251S Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	2.250	2.350	0.089	0.093		
A1	1.150	1.250	0.045	0.049		
В	10.200	10.800	0.402	0.425		
b	0.550	0.650	0.022	0.026		
b1	0.750	0.850	0.030	0.033		
С	0.480	0.540	0.019	0.021		
c1	0.480	0.540	0.019	0.021		
D	6.400	6.600	0.252	0.260		
D1	5.250	5.350	0.207	0.211		
E	5.400	5.600	0.213	0.220		
e1	2.300 TYP		0.091 TYP			
e2	2.30	2.300 TYP		0.091 TYP		
L	3.300	3.700	0.130	0.146		







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